

## 1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.

## 2. Features and benefits

- Highly stable switching performance
- High forward surge capability  $I_{FSM}$
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability ( $T_{j(max)} = 175^\circ\text{C}$ )

## 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

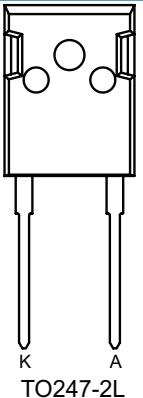
## 4. Quick reference data

**Table 1. Quick reference data**

| Symbol                         | Parameter                       | Conditions  | Values |      |      | Unit |
|--------------------------------|---------------------------------|---|--------|------|------|------|
| <b>Absolute maximum rating</b> |                                 |   |        |      |      |      |
| $V_{RRM}$                      | repetitive peak reverse voltage |   |        |      | 1200 | V    |
| $I_{F(AV)}$                    | average forward current         | $\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 131^\circ\text{C}$ ; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> ; <a href="#">Fig. 4</a> |        |      |      | A    |
| $T_j$                          | junction temperature            |   |        |      | 175  | °C   |
| Symbol                         | Parameter                       | Conditions  | Min    | Typ  | Max  | Unit |
| <b>Static characteristics</b>  |                                 |   |        |      |      |      |
| $V_F$                          | forward voltage                 | $I_F = 20\text{ A}; T_j = 25^\circ\text{C}$ ; <a href="#">Fig. 6</a>  | -      | 1.4  | 1.6  | V    |
|                                |                                 | $I_F = 20\text{ A}; T_j = 150^\circ\text{C}$ ; <a href="#">Fig. 6</a>   | -      | 1.85 | 2.3  | V    |
|                                |                                 | $I_F = 20\text{ A}; T_j = 175^\circ\text{C}$ ; <a href="#">Fig. 6</a>   | -      | 2    | 2.6  | V    |
| <b>Dynamic characteristics</b> |                                 |   |        |      |      |      |
| $Q_r$                          | recovered charge                | $I_F = 20\text{ A}; V_R = 400\text{ V}; dI_F/dt = 500\text{ A}/\mu\text{s}$ ; $T_j = 25^\circ\text{C}$ ; <a href="#">Fig. 8</a>   | -      | 52   | -    | nC   |

## 5. Pinning information

**Table 2. Pinning information**

| Pin | Symbol | Description                         | Simplified outline   | Graphic symbol   |
|-----|--------|-------------------------------------|--|--|
| 1   | K      | cathode                             |  |  |
| 2   | A      | anode                               |  |  |
| mb  | K      | mounting base; connected to cathode |  | <br>001aaa020 |

## 6. Ordering information

**Table 3. Ordering information**

| Type number  | Package name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date |
|--------------|--------------|-----------------------|----------------|------------------------|-----------------|--------------------|
| GKTSC201200W | TO247-2L     | GKTSC201200WQ         | Tube           | 30                     | TO247L-2L       | 10-Nov-2015        |

## 7. Marking

**Table 4. Marking codes**

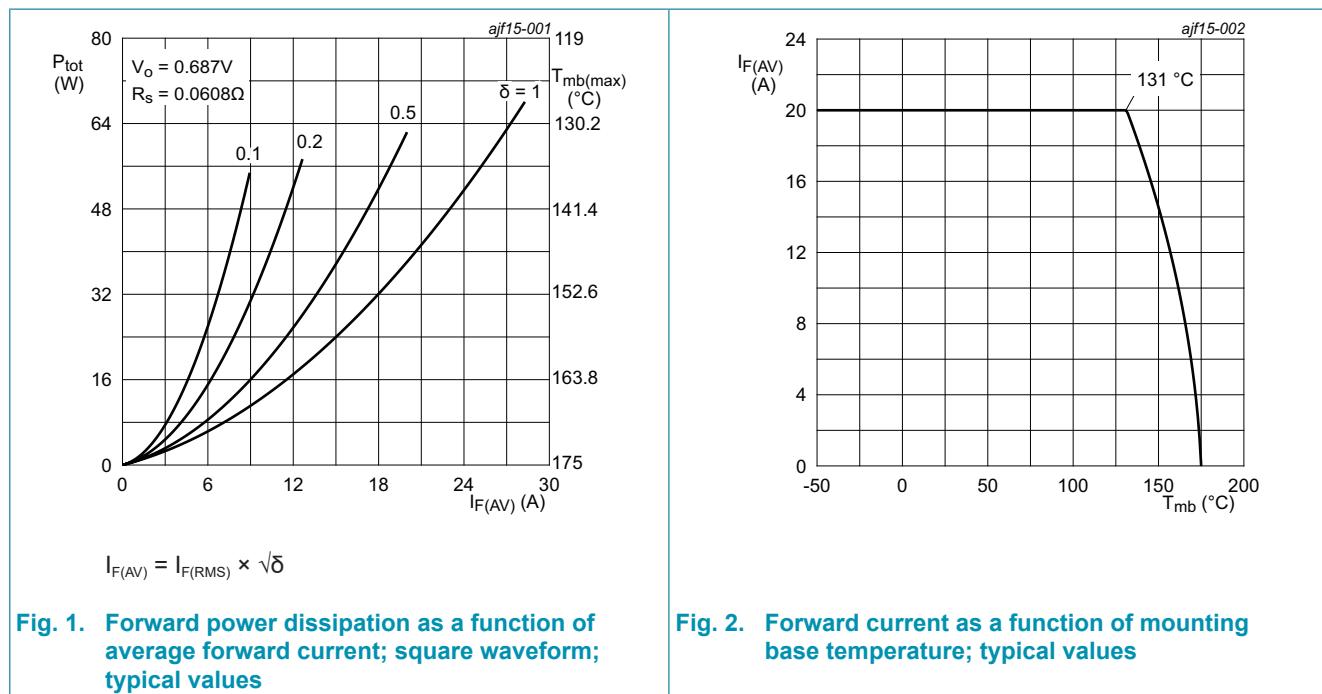
| Type number  | Marking codes |
|--------------|---------------|
| GKTSC201200W | GKTSC201200W  |

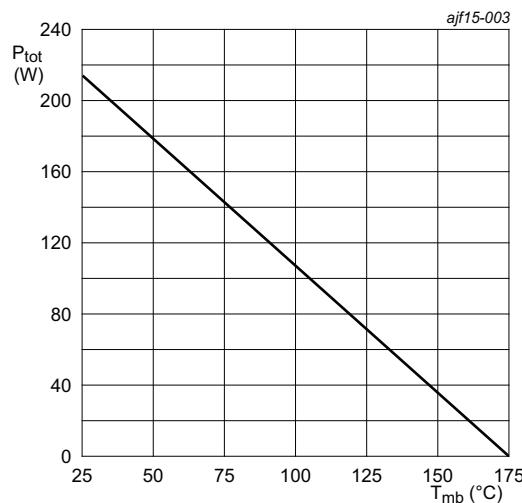
## 8. Limiting values

**Table 5. Limiting values**

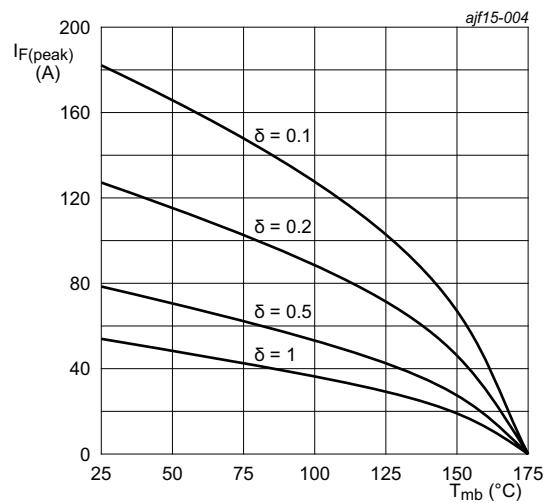
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol      | Parameter                           | Conditions   | Values     | Unit |
|-------------|-------------------------------------|--|------------|------|
| $V_{RRM}$   | repetitive peak reverse voltage     |  | 1200       | V    |
| $V_{RWM}$   | crest working reverse voltage       |  | 1200       | V    |
| $V_R$       | reverse voltage                     | DC   | 1200       | V    |
| $I_{F(AV)}$ | average forward current             | $\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 131$ °C;<br><a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> ; <a href="#">Fig. 4</a> | 20         | A    |
| $I_{FRM}$   | repetitive peak forward current     | $\delta = 0.5$ ; $t_p = 25$ µs; $T_{mb} \leq 131$ °C;<br>square-wave pulse   | 40         | A    |
| $I_{FSM}$   | non-repetitive peak forward current | $t_p = 10$ ms; $T_{j(init)} = 25$ °C; sine-wave pulse  | 220        | A    |
|             |                                     | $t_p = 10$ µs; $T_{j(init)} = 25$ °C; sine-wave pulse  | 1440       | A    |
| $I^2t$      | $I^2t$ for fusing                   | sine-wave pulse; $T_{j(init)} = 25$ °C; $t_p = 10$ ms  | 242        | A²s  |
| $T_{stg}$   | storage temperature                 |  | -55 to 175 | °C   |
| $T_j$       | junction temperature                |  | 175        | °C   |





**Fig. 3. Total power dissipation as a function of mounting base temperature**

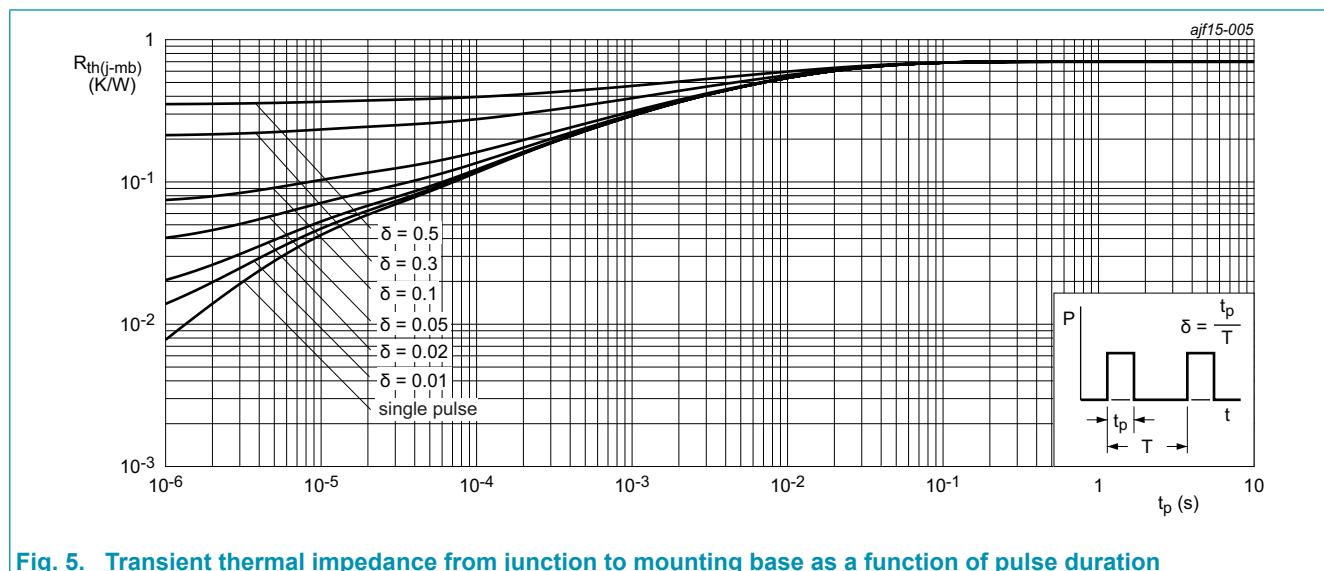


**Fig. 4. Current derating as a function of mounting base temperature**

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

| Symbol                | Parameter  | Conditions             |  | Min | Typ | Max | Unit |
|-----------------------|--|------------------------|--|-----|-----|-----|------|
| $R_{th(j\text{-mb})}$ | thermal resistance from junction to mounting base    | <a href="#">Fig. 5</a> |  | -   | -   | 0.7 | K/W  |
| $R_{th(j\text{-a})}$  | thermal resistance from junction to ambient free air | in free air            |  | -   | 40  | -   | K/W  |

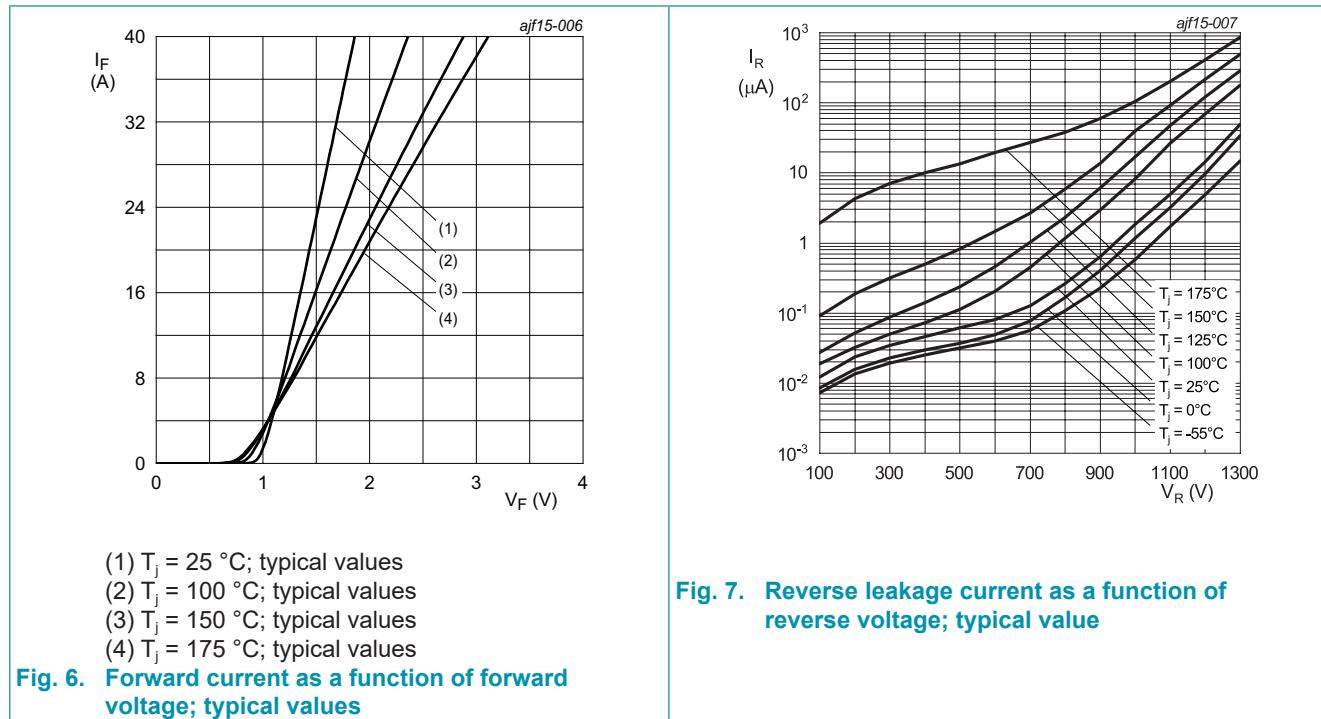


**Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration**

## 10. Characteristics

**Table 7. Characteristics**

| Symbol                         | Parameter         | Conditions   |  | Min | Typ  | Max | Unit          |
|--------------------------------|-------------------|--|--|-----|------|-----|---------------|
| <b>Static characteristics</b>  |                   |  |  |     |      |     |               |
| $V_F$                          | forward current   | $I_F = 20 \text{ A}; T_j = 25^\circ\text{C}$ ; Fig. 6  |  | -   | 1.4  | 1.6 | V             |
|                                |                   | $I_F = 20 \text{ A}; T_j = 150^\circ\text{C}$ ; Fig. 6   |  | -   | 1.85 | 2.3 | V             |
|                                |                   | $I_F = 20 \text{ A}; T_j = 175^\circ\text{C}$ ; Fig. 6   |  | -   | 2    | 2.6 | V             |
| $I_R$                          | reverse current   | $V_R = 1200 \text{ V}; T_j = 25^\circ\text{C}$ ; Fig. 7  |  | -   | 20   | 220 | $\mu\text{A}$ |
|                                |                   | $V_R = 1200 \text{ V}; T_j = 175^\circ\text{C}$ ; Fig. 7   |  | -   | 900  | -   | $\mu\text{A}$ |
| <b>Dynamic characteristics</b> |                   |  |  |     |      |     |               |
| $Q_r$                          | recovered charge  | $I_F = 20 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s}$ ; $T_j = 25^\circ\text{C}$ ; Fig. 8 |  | -   | 52   | -   | nC            |
| $C_d$                          | diode capacitance | $f = 1 \text{ MHz}; V_R = 1 \text{ V}; T_j = 25^\circ\text{C}$   |  | -   | 1020 | -   | pF            |
|                                |                   | $f = 1 \text{ MHz}; V_R = 400 \text{ V}; T_j = 25^\circ\text{C}$   |  | -   | 96   | -   | pF            |
|                                |                   | $f = 1 \text{ MHz}; V_R = 800 \text{ V}; T_j = 25^\circ\text{C}$   |  | -   | 82   | -   | pF            |



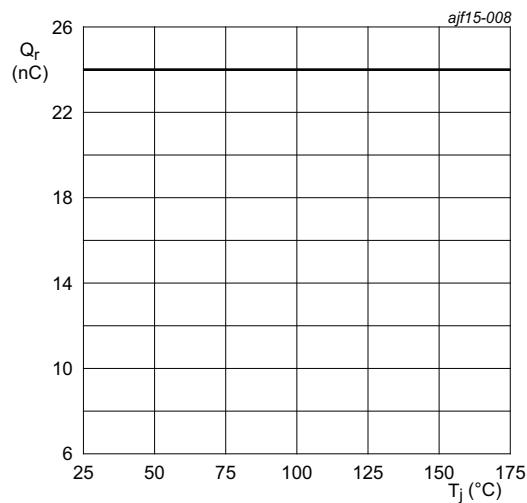
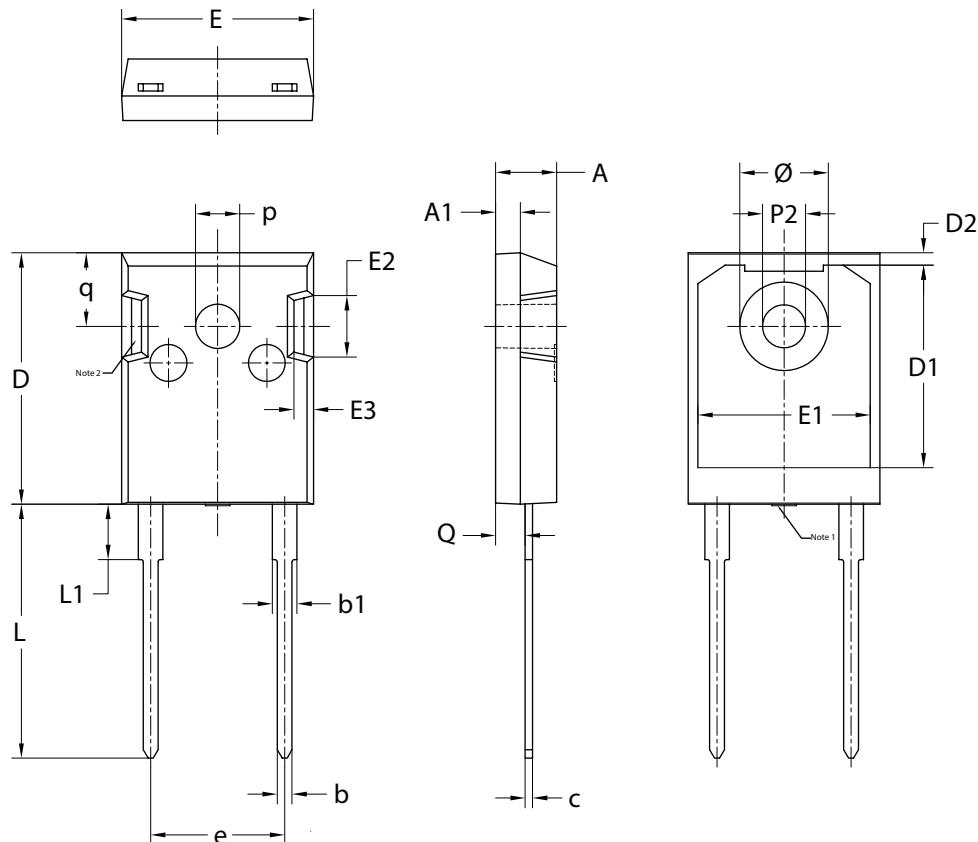


Fig. 8. Recovered charge as a function of junction temperature

## 11. Package outline

Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 2 leads TO-247

TO247-2L



| UNIT | A            | $A_1$        | b            | $b_1$        | c            | D              | $D_1$          | $D_2$        | E              | $E_1$          | $E_2$        | $E_3$        | e            | L              | $L_1$        | $P_2$        | p            | Q            | q            | Ø            |
|------|--------------|--------------|--------------|--------------|--------------|----------------|----------------|--------------|----------------|----------------|--------------|--------------|--------------|----------------|--------------|--------------|--------------|--------------|--------------|--------------|
| mm   | 5.20<br>4.70 | 2.10<br>1.90 | 1.40<br>1.00 | 2.20<br>1.80 | 0.70<br>0.50 | 20.60<br>20.30 | 16.20<br>16.87 | 1.20<br>0.80 | 15.75<br>15.45 | 14.22<br>13.82 | 5.20<br>4.80 | 1.80<br>1.40 | 10.90<br>BSC | 20.72<br>20.22 | 4.75<br>4.25 | 3.60<br>3.40 | 3.70<br>3.50 | 2.60<br>2.20 | 6.18<br>5.78 | 7.30<br>7.10 |

Note:

1. Mold resin protrusion max 0.127mm.
2. Metal exposed with Sn plating.

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